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TLC59213, TLC59213A

SLVS867B-MAY 2009-REVISED AUGUST 2015

TLC59213x 8-Bit Parallel In and Out Darlington Source Driver With Latch

1 Features

- Output Current on Each Channel (I_{OUT} Max = -500 mA)
- V_{CE(sus)} = 13.2 V
- Input Compatible With TTL/5-V CMOS
- Clear (CLR) and Clock (CLK) TTL/CMOS Control Inputs
- CLR Control Input to Off the Output
- Darlington Source Driver
- Clock Input Up to 1 MHz
- Enhanced Hold Time (t_h) on TLC59213A
- Temperature Range: –40°C to 85°C

2 Applications

- Lamp and Display (LED)
- Hammer
- Relay

3 Description

The TLC59213 and TLC59213A are 8-bit source drivers with input latch with CLK input and CLR to set the output OFF. The TLC59213 and TLC59213A have large output source currents up to 500 mA with Darlington transistor and collectors tied to V_{CC} . These feature make the device optimum level of driving the matrix of ink jet printer head, LEDs, and the scan-side of resistor's matrix. The TLC59213 and TLC59213A differ only in the Data Hold Time Specification (t_h).

The clamp diode is between output and ground for switching inductive load.

All inputs are TTL/CMOS, which enable to any logiclevel inputs such as MCU, CPU or SN74LV594 (serial to parallel) and the output enable LED matrix display. It can also be used with another device sink driver such as TLC59210, TLC59211 and TLC59212.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)					
TLC59213	PDIP (20)	24.33 mm × 6.35 mm					
TLC59213A	TSSOP (20)	6.50 mm × 4.40 mm					

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Typical Application Diagram÷



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision A (March 2010) to Revision B

Added Pin Configuration and Functions section, ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device

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5 Pin Configuration and Functions

N or PW Package 20-Pin PDIP or TSSOP Top View						
	1	U	20	Vcc		
D1 [2		19] Y1		
D2 [3		18] Y2		
D3 [4		17] Y3		
D4 [5		16] Y4		
D5 🗌	6		15] Y5		
D6 🗌	7		14] Y6		
D7 [8		13] Y7		
D8 [9		12] Y8		
CLK [10		11	GND		

Pin Functions

PIN		1/0	DESCRIPTION		
NAME	NO.	1/0	DESCRIPTION		
CLR	1	I	Direct clear of output		
D1	2	I	Input control to the current source driver		
D2	3	I	Input control to the current source driver		
D3	4	I	Input control to the current source driver		
D4	5	I	Input control to the current source driver		
D5	6	I	Input control to the current source driver		
D6	7	I	Input control to the current source driver		
D7	8	I	Input control to the current source driver		
D8	9	I	Input control to the current source driver		
CLK	10	I	Clock to positive edge triggered D flipflops		
GND	11	—	Ground		
Y8	12	0	Output to load		
Y7	13	0	Output to load		
Y6	14	0	Output to load		
Y5	15	0	Output to load		
Y4	16	0	Output to load		
Y3	17	0	Output to load		
Y2	18	0	Output to load		
Y1	19	0	Output to load		
V _{cc}	20	I	Supply voltage		



6 Specifications

6.1 Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{DD}	Supply voltage		-0.5	15	V
VI	Input voltage		-0.5	V _{CC} + 0.5	V
	Collector-emitter voltage		-0.5	15	V
I _O	Peak output current			-500	mA
I _{IK}	Input clamp current	V ₁ < 0 V		-20	mA
I _{OK}	Output clamp current	V _O < 0 V		-500	mA
T _{stg}	Storage temperature		-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			VALUE	UNIT
		Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	
V _(ESD)	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 $^{\left(2\right)}$	±1000	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

				MIN	MAX	UNIT
V _{CC}	Supply voltage			4.5	13.2	V
VIH	High-level input voltage			2		V
VIL	Low-level input voltage			0.8	V	
		Nasakaga	Duty cycle < 10%		400	
I _O Output current (8 channel)	Quitaut aurrent (8 abannal)	п раскаде	Duty cycle < 50%		200	mA
	Output current (8 channel)		Duty cycle < 10%		350	
		Duty cycle < 50%			170	
T _A	Operating free-air temperature			-40	85	°C

6.4 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CO	DITIONS	MIN	TYP	MAX	UNIT
I _{CEX}	Output leakage current	V_{CC} = 13.2 V, Outputs off				2	μA
		I _{OUT} = -350 mA				2.35	
V _{CE(sus)}	Output saturation voltage	I _{OUT} = -225 mA	I _{OUT} = -225 mA			2.15	V
		$I_{OUT} = -100 \text{ mA}$				1.96	
l _l	Input current	$V_{CC} = 13.2 \text{ V}, \text{ V}_{I} = 0 \text{ or } 13.2 \text{ V}$	V _{CC} = 13.2 V, V _I = 0 or 13.2 V			1	μA
V _f	Clamp forward voltage	I _f = -350 mA		-2			V
	Cupply ourrent	V _{CC} = 13.2 V,	All outputs OFF		4.6	13	~ ^
ICC	Supply current	V _I = 0 or 13.2 V	All outputs ON		4.8	13	ШA
CI	Input capacitance					10	pF



6.5 Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted), see Figure 3

					MIN	MAX	UNIT
t _{su} Setup time		D before CLK ↑			50		ns
		CLR high before CLK ↑			50		ns
			TLC59213, TLC59213A	$T_A = -40^{\circ}C$ to $85^{\circ}C$	50		
t _h	Hold time	I time D after CLK ↑	TLC59213	$T_A = 0^{\circ}C$ to $70^{\circ}C$	25		ns
			TLC59213A	$T_A = 0^{\circ}C$ to 70°C, $V_{CC} = 4.5$ V to 5.5 V	15		
				$T_A = 0^{\circ}C$ to 70°C, $V_{CC} = 10.8$ V to 13.2 V	19		
tw	Pulse width	CLK, CLR			100		ns

6.6 Switching Characteristics

over operating free-air temperature range (unless otherwise noted), see Figure 3

	DADAMETED	FROM	TO TEST $T_A = 25^{\circ}C$		С	T _A = -40°C to 85°C			
	FARAMETER	(INPUT)	(OUTPUT)	CONDITIONS	MIN	TYP	MAX	MIN MAX	UNIT
t _{PLH}	Propagation delay time, low-to-high level output	CLK	Y	RL = 25 Ω, C _L = 15 pF		107	200	250	ns
t _{PHL}	Propagation delay time, high-to-low level output	CLK	Y	RL = 25 Ω, C _L = 15 pF		111	200	250	ns
t _{PHLR}	Propagation delay time, high-to-low level output	CLR	Y	RL = 25 Ω, C _L = 15 pF		104	200	250	ns

6.7 Typical Characteristics



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7 Parameter Measurement Information







VOLTAGE WAVEFORMS

- A. C_L includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z₀ = 50 Ω , t_r \leq 3 ns, and t_f \leq 3 ns.
- C. The outputs are measured one at a time with one transition per measurement.

Figure 3. Test Circuit and Voltage Waveforms

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8 Detailed Description

8.1 Overview

The TLC59213 device is an 8-bit Darlington source driver with latch for large-output source currents up to 500 mA.

8.2 Functional Block Diagram



(1) This symbol is in accordance with ANSI/IEEE Standard 91-1984 and IEC Publication 617-12.

8.3 Feature Description

Each of the 8 channels is controlled by its input (Dn), a direct clear (\overline{CLR}), and clock (CLK) through a positiveedge-triggered D-type flip-flops. Information at the data (D) input meeting the setup time requirements is transferred to the output (Y) on the positive-going edge of the clock (CLK) pulse. When CLK is at either the high or low level, the D-input has no effect at the output. When \overline{CLR} is at low level, the D-input has no effect at the output.

8.4 Device Functional Modes

Table 1 lists the functional modes of the TLC59213.

	OUTPUT		
CLR	CLK	D	Y
L	Х	Х	Z (OFF)
Н	↑ (L	Z (OFF)
Н	↑ (н	H (ON)
Н	L	Х	Y ₀
Н	Ļ	Х	Y ₀

Table 1. Function Table (Each Latch)⁽¹⁾

(1) L: Low-level

H: High-level

X: Irrelevant

↑: Rising edge ↓: Falling edge

Z : High-impedance (OFF)



9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

In LED display application, TLC59213 is used to drive the current source for 8 LEDs in parallel. LED display pattern can be created by providing different bit pattern. At every positive clock edge, new bit pattern will be transferred to LED display.

9.2 Typical Application



Figure 4. Typical Application Diagram

9.2.1 Design Requirements

For LED display application, LED is selected based on the application. The current level is determined by the required brightness. Given the available supply, the resistor value could be determined. The maximum output current is constrained by the duty cycle. See Figure 1 and Figure 2.

9.2.2 Detailed Design Procedure

The selection of supply voltage (VCC), LED, and resistor sets the current of the LED.

$$VR + VL + VCE = VCC$$
(1)
I = (VCC - VL - VCE) /R (2)

VR is the voltage drop across the resistor, VL is the voltage drop across the LED when LED is on, VCE is the collector-to-emitter voltage of the Darlington current source driver, when the driver is enabled. For example, when VCC = 12 V, VL = 2.9 V, and VCE = 1.6 V, a 75- Ω resistor is used to obtain output current 100 mA.



Typical Application (continued)

9.2.3 Application Curve



Figure 5. Output Voltage and Current Response

10 Power Supply Recommendations

The supply voltage to TLC59213 is from 4.5 V to 13.2 V.

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11 Layout

11.1 Layout Guidelines

The traces that carry current from the output pins must be wide enough to support the current.

11.2 Layout Example



◯ VIA to GND

Figure 6. Layout Recommendation



12 Device and Documentation Support

12.1 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

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Design Support TI's Design Support Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.2 Trademarks

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

12.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.4 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
	. ,						(6)			、 <i>,</i>	
TLC59213AIN	ACTIVE	PDIP	Ν	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	-40 to 85	TLC59213AIN	Samples
TLC59213AIPW	ACTIVE	TSSOP	PW	20	70	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		Y59213A	Samples
TLC59213AIPWR	ACTIVE	TSSOP	PW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	Y59213A	Samples
TLC59213AIPWT	ACTIVE	TSSOP	PW	20	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	Y59213A	Samples
TLC59213IN	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	-40 to 85	TLC59213IN	Samples
TLC59213IPWR	ACTIVE	TSSOP	PW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	Y59213	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



10-Dec-2020

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STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC59213AIPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1
TLC59213AIPWT	TSSOP	PW	20	250	180.0	16.4	6.95	7.0	1.4	8.0	16.0	Q1
TLC59213IPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.0	1.4	8.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

3-Jun-2022



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC59213AIPWR	TSSOP	PW	20	2000	356.0	356.0	35.0
TLC59213AIPWT	TSSOP	PW	20	250	210.0	185.0	35.0
TLC59213IPWR	TSSOP	PW	20	2000	356.0	356.0	35.0

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3-Jun-2022

TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
TLC59213AIN	N	PDIP	20	20	506	13.97	11230	4.32
TLC59213AIPW	PW	TSSOP	20	70	530	10.2	3600	3.5
TLC59213IN	N	PDIP	20	20	506	13.97	11230	4.32

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



PW0020A



PACKAGE OUTLINE

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



PW0020A

EXAMPLE BOARD LAYOUT

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



PW0020A

EXAMPLE STENCIL DESIGN

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



LAND PATTERN DATA



NOTES: Α. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
 C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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